

ARB011

Photointerrupter - Transmissive Type

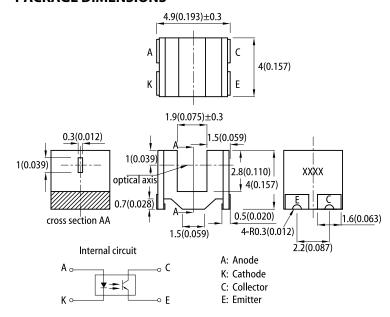
FEATURES

- Ultra-compact
- High sensing accuracy (Slit width: 0.3mm)
- Gap between light emitter and detector: 1.9mm
- Moisture sensitivity level: 4
- Package: 1500 pcs / reel
- RoHS compliant

APPLICATIONS

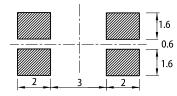
- Floppy disk drives, Camera
- · Various microcomputerized control equipment

PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

(units: mm; tolerance: ± 0.15)



- 17016s.

 1. All dimensions are in millimeters (inches).

 2. Tolerance is ±0.15(0.006") unless otherwise noted.

 3. The specifications, characteristics and technical data described in the datasheet are subject to
- change without prior notice.

 4. The device has a single mounting surface. The device must be mounted according to the specifications.

ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

	Parameter	Cumbal	Value			l lmi4	Conditions
Parameter		Symbol	Min.	Тур.	Max.	Unit	Conditions
Input	Forward voltage	V _F	-	1.1	1.3	V	IF=5mA
	Reverse current	I _R	-	-	10	μA	VR=5V
Output	Collector current	Ic	50	650	-	μA	IF=5mA,VcE=5V
	Collector dark current	I _D	-	-	100	nA	VCE =10V, 0LX
	Collector-emitter saturation voltage	V _{CE(sat)}	-	0.1	0.4	V	Ic=50µA, IF=20mA
Rise time		t _r	-	8	-		VCE=5V,
Fall time		t _f	-	10	-	μs	RL=1K Ω Ic=100μA

^{1.} Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

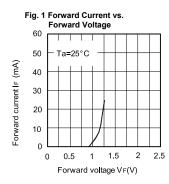


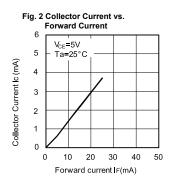
ABSOLUTE MAXIMUM RATINGS at T_A=25°C

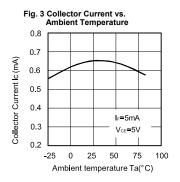
	Parameter	Symbol	Rating	Unit
	Forward current [1]	l _F	25	mA
Input	Reverse voltage	V _R	5	V
	Power dissipation	P _D	35	mW
	Collector-emitter voltage	V _{CEO}	20	V
Outrut	Emitter-collector voltage	V _{ECO}	5	V
Output	Collector current	Ic	20	mA
	Collector power dissipation	P _C	75	mW
Operating temperature		T _{opr}	-30~+85	°C
Storage temperature		T _{stg}	-40~+90	°C
Manual soldering [2]		T _{sol}	300	°C

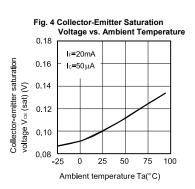
Notes:

TECHNICAL DATA





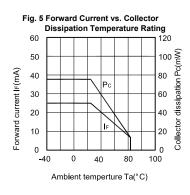


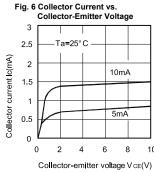




^{1.} Refer to the temperature rating chart if the ambient temperature exceeds 25°C.
2. Complete soldering within 3 seconds.
3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.







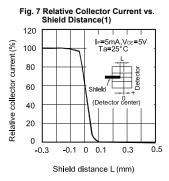
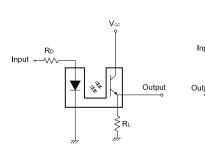


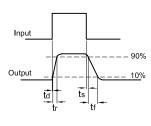
Fig. 8 Relative Collector Current vs. Shield Distance(2) 120 Ir=5mA,VcE=5V Relative collector current (%) 100 Ta=25°C Shleid 80 60 (Detector 40 20 0 -0.3 0 0.3 -0.9 0.9 1.2 Shield distance L (mm)

Fig. 9 Response Time vs. Load Resistance 100 Vc=5V Ic=100μA Ta=25° C 10 Response time (us) 0.1

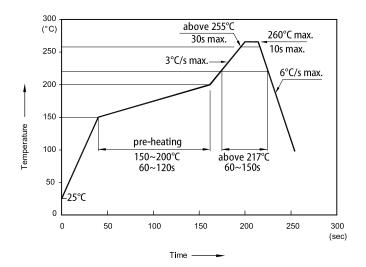
Load resistance $R_L(k\Omega)$



Test Circuit for Response Time

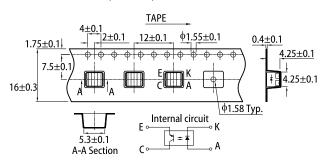


REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

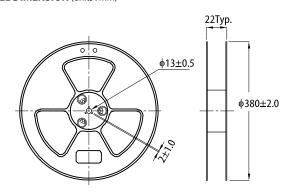


- Don't cause stress to the LEDs while it is exposed to high temperature.
 The maximum number of reflow soldering passes is 2 times.
 Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

TAPE SPECIFICATIONS (units: mm)



REEL DIMENSION (units: mm)





PACKING & LABEL SPECIFICATIONS

